Japan Laser Processing Society (hear in after “JLPS”) is committed to protecting your personal data. This notice outlines how we collect, share and use your personal data, and how you can exercise your privacy rights involving your data.

Where We Collect Personal Data From:

JLPS receives your personal data from these sources:

* Websites (JLPS owned or managed), including http://www.jlps.gr.jp/, http://www.jlps.gr.jp/jlmn/index.php, and where you create accounts to access products and services for LPM/SLPC symposium & LAMP congress, the online proceeding submission system of each symposium/congress, and for submission to the access-free journal, “Journal of Laser Micro/Nanoengineering (JLMN)”.

* Submission to JLPS Domestic conferences & the proceedings (講演会論文集), and the membership journal, “Journal of Japan Laser Processing Society”(レーザ加工学会誌).

* JLPS-contracted vendors who provide a specific service related to the delivery of a product or service, including those for which you provide registration information such as, paper submissions, conference registrations, career searches, grant applications.

* Third-party individuals, including corresponding authors providing information about you as a co-author or potential reviewer/editors

* JLPS-contracted partners, including co-sponsors for meetings and peer societies.

* Your correspondence to us via mail, email or fax.

What Personal Data We Collect

The personal data collected by JLPS falls into these categories:

- Identifying data, including name, and photo for symposium/congress award ceremony and the photo gallery on website after the event
- Contact data, including email addresses, physical addresses and telephone numbers.
- Demographic data, including nationality, birth year, gender, dietary restrictions, family member names and emergency contact
- Financial data, including transaction details about purchases you have made, and payments to and from you.
- Professional data, including CVs, technical and research interests, educational background, and employers.
- JLPS-related activity data, including author and reviewer history, volunteer activities, customer service communications.
- Technical data, including internet protocol (IP) address, browser type and version, broad geographic location, device type, operating system and other technical information. We may also collect information about how your device has interacted with our websites, including the web pages accessed and links clicked on.
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<th>For</th>
<th>Your personal information</th>
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<tr>
<td>Abstract (One-Page Digest) submission for LPM/LAMP/SLPC</td>
<td>Presenting/corresponding author’s name, affiliation, company name, department, street address, city, state/prefecture, ZIP-code, country, e-mail address, Tel/Fax number, title (Prof. Dr. Mr. Ms.), co-authors’ names and their affiliations should be inputted in the submission system.</td>
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<tr>
<td>Abstract booklet</td>
<td>Your e-mail address will be used for the various announcements/ notices (e.g. Acceptance Notice) from the symposium/congress secretariat (e.g. <a href="mailto:lamp2019@jlps.gr.jp">lamp2019@jlps.gr.jp</a>, <a href="mailto:lamp-abst@jlps.gr.jp">lamp-abst@jlps.gr.jp</a>)</td>
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<tr>
<td>&quot;Program &amp; Technical Digest&quot; of LPM/LAMP/SLPC (Hardcopy and/or electric file)</td>
<td>All authors’ names, affiliations, company names, departments, street addresses, cities, states/prefectures, ZIP-codes, countries, e-mail address of corresponding author will be printed in the booklet.</td>
</tr>
<tr>
<td>Registration system (including On-site Registration) for LPM/LAMP/SLPC</td>
<td>Name, affiliation, company name, department, street address, city, state/prefecture, ZIP-code, country, e-mail address, Tel/Fax number, title (Prof. Dr. Mr. Ms.), should be inputted in the registration system. (In case of inputting your personal information by your own secretary, please be sure to give him/her the permission from you.)</td>
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<tr>
<td>Japanese VISA support for attending LPM/LAMP/SLPC</td>
<td>In order to attend JLPS-organized event, if you would like to receive any supports for obtaining Japanese VISA support from the event secretariat, the following information will be required. (Support arrangements will be managed by either JLPS or the LPM/LAMP/SLPC designated vendors, e.g. JTB Communication Design. Inc.) Your name (and accompanying family person’s name, if any), title (Prof. Dr. Mr. Ms.), nationality, birthday (Year/Month/Date), affiliation, company name, department, street address, city, state/ prefecture, ZIP-code, country, travel schedule in Japan, flight information, staying hotel name(s), e-mail address and direct shipping address and Tel number in order to send you supporting documents by EMS from Japan.</td>
</tr>
<tr>
<td>Manuscript Submission to LPM/LAMP online proceedings</td>
<td>First/corresponding author’s name, affiliation, company name, department, street addresses, city, state/prefecture, ZIP-code, country name, e-mail address, Tel/Fax number, title (Prof. Dr. Mr. Ms.), co-authors’ names and their affiliations, initial abstract number should be inputted in the submission system.</td>
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<td>Copyright Transfer Form for LPM/LAMP Proceedings</td>
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<td>Publication Charge Form for JLMN (After Acceptance Notice)</td>
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<td>Manuscript Submission to JLPS's Japanese journal &quot;Journal of Japan Laser Processing Society (Hardcopy and electric file) (レーザ加工学会誌 依頼原稿表紙)</td>
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<td>Registration for JLPS's Laser Materials Processing Conference (レーザ加工学会講演会 参加申込)</td>
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### How We Use Personal Data

JLPS uses your personal data to:

- Process and deliver a product or service you have ordered.
  - In some cases, this will require JLPS to share your data with a third-party provider. In these cases, a contractual arrangement is in place to ensure the protection of the data and the minimal transfer of data necessary to complete the task that is shared. For example, accepted manuscripts – which include author contact information – are shared with our publishing vendors to prepare the article for publication.
  - In other cases, JLPS contracts with a partner to provide a product or service and data is shared with or received from the partner. For example, a co-sponsor of a meeting, a peer society that processes joint memberships, or a sister society that provides a member benefit.
- Provide information to you about other relevant JLPS programs and services based on your interests.
- Include your information in our online directory.
- Improve your online experience. For example, we keep you logged in to our network as you read online journal content.
- Share conference registration lists with attendees and sponsors.
- Monitor JLPS content and services to prevent potentially abusive activities.
- Share mailing addresses with JLPS members.
• Respond to a competent law enforcement body, regulatory, government agency, court or other third party where we believe disclosure is legally required; to exercise, establish or defend our legal rights; or to protect your vital interests or those of any person.

In connection with any proposed purchase, merger or acquisition of any part of our business, your data may be sold or transferred as part of that transaction with the stipulation that the conditions of this privacy policy transfer with the data. Personal information data related to the LPM/LAMP/SLPC symposium will be erased within three years after the event.

Your Data Rights

You may access the majority of the information that JLPS maintains on you in our database in the My Account (JLPS Membership login ID and Password) feature of our system; e.g. Manuscript search at Cybozu Dedie（サイボウズ デヂエ） for JLPS members. Author and reviewing information is contained in electric files of JLPS publishing proceedings of LPM/LAMP/SLPC symposium/congress, Proceedings of Laser Materials Processing Conference (講演会論文集), Journal of Japan Laser Processing Society (学会誌), our open-access online journal “Journal of Laser Micro/Nanoengineering (JLMN)”. Questions or concerns about your data may be sent to jlps@jlps.gr.jp

Cookies and Other Tracking Technologies

To enhance the performance and functionality of our sites, we use session, persistent and third-party “cookies” that store a small text file on your computer and collect certain information about your visit to our site.

Log Files

Web site log files store information such as internet protocol (IP) addresses, browser type, internet service provider (ISP), referring/exit pages, platform type, date/time stamp, and number of clicks. Normally, an IP address will change each time you connect to the internet; in some cases, however, you may have a static address, and your IP address may be deemed identifiable. Log files are used to analyze trends, administer the site, track users' movements within the site and gather broad demographic information for aggregate use. The log files are used by utility tracking software to analyze user movement.

Transfer of Information to Other Countries

JLPS is a global organization headquartered in Japan but with activities, members, customers, vendors and consultants around the world. In the course of normal business, JLPS may transfer information to other countries as necessary for us to provide our products and services. By submitting your information to JLPS (electronically or in hard copy), you consent to such transfers and to the processing of this information in other countries.

Modifications to this Notice

JLPS may modify, add or remove portions of this Privacy Notice at any time. Where such changes are material in nature, JLPS will provide additional notice via email or notification on the Websites. The date of the last update is displayed at the top of this Privacy Notice.
Contact Information

If you have any questions or suggestions regarding this Privacy Notice, please contact JLPS at:

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